



Product/Process Change Notice - PCN 22_0122 Rev. -

Analog Devices, Inc. One Analog Way, Wilmington, MA 01887

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title: ADuCM430 change of die adhesive material

Publication Date: 27-Jun-2022

Effectivity Date: 29-Sep-2022 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:

Initial Release

Description Of Change:

Change Die Attach material for Eflash dies of ADuCM430 from Ablestik QMI536 epoxy to Hitachi HR5104 film.

Reason For Change:

Hitachi HR5104 film provides better die placement and increased manufacturability.

Impact of the change (positive or negative) on fit, form, function & reliability:

There is no change on fit, form, function & reliability.

Product Identification *(this section will describe how to identify the changed material)*

Changed product can be identified by DateCode 2226 and newer

Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results.

Supporting Documents

Attachment 1: Type: Other

ADI_PCN_22_0122_Rev_-_ADUCM430 Die Attach Film Qualification Report.pdf

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:
PCN_Americas@analog.com

Europe:
PCN_Europe@analog.com

Japan:
PCN_Japan@analog.com

Rest of Asia:
PCN_ROA@analog.com

Appendix A - Affected ADI Models				
Added Parts On This Revision - Product Family / Model Number (3)				
ADUCM430 / ADUCM430BBCZ	ADUCM430 / ADUCM430BBCZ-RL	ADUCM430 / ADUCM430BBCZ-RL7		

Appendix B - Revision History			
Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	27-Jun-2022	29-Sep-2022	Initial Release

Analog Devices, Inc.

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